

## FEATURES

- Compatible with the ISO 11898-2:2024, SAE J2284-1 to SAE J2284-5 and SAE J1939-14 standard;
- Thermally protected;
- ±58V BUS protection;
- ±30V bus common mode voltage;
- Driver (TXD) and standby bus (BUS) dominant timeout function;
- Low-power standby mode with wake-up function;
- SIT1042GT/3 and SIT1042GTK/3 I/O can be interfaced directly to microcontrollers with supply voltages 1.8V, 3.3V and 5V;
- Undervoltage protection on VCC and VIO power supply pins;
- High-speed CAN, supporting the optimized 8Mbps Flexible Data-Rate (CAN FD);
- High Electro-Magnetic Immunity (EMI) and Low Electro-Magnetic Emission (EME);
- Unpowered state disengages from the bus;
- Available in SOP8 and leadless DFN3\*3-8 packages.

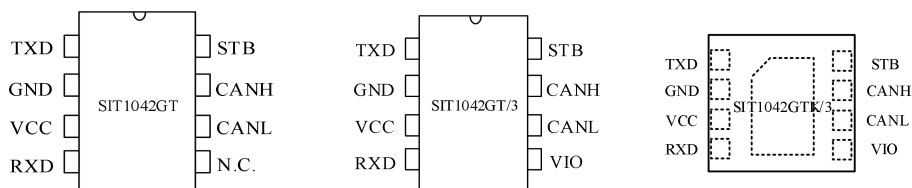
## DESCRIPTION

SIT1042G is an interface chip used between the CAN protocol controller and the physical bus. It can be used for industrial control and other fields. It supports 8Mbps (CAN FD), and has the ability to perform differential signal transmission between bus and the CAN protocol controller.

The SIT1042G is fully compatible with the SIT1042, SIT1042A, and other family products. The SIT1042G is an upgraded version with improved EMC performance and lower electromagnetic radiation performance. In addition, the SIT1042G can support 1.8V MCU.

| PARAMETER                         | SYMBOL            | MIN. | MAX. | UNIT |
|-----------------------------------|-------------------|------|------|------|
| Bus supply voltage                | VCC               | 4.5  | 5.5  | V    |
| MCU side port supply voltage      | VIO               | 1.7  | 5.5  | V    |
| CANH/CANL input or output voltage | V <sub>can</sub>  | -58  | +58  | V    |
| Bus differential voltage          | V <sub>diff</sub> | 1.5  | 3.0  | V    |
| Virtual junction temperature      | T <sub>j</sub>    | -40  | 150  | °C   |

## PIN CONFIGURATION

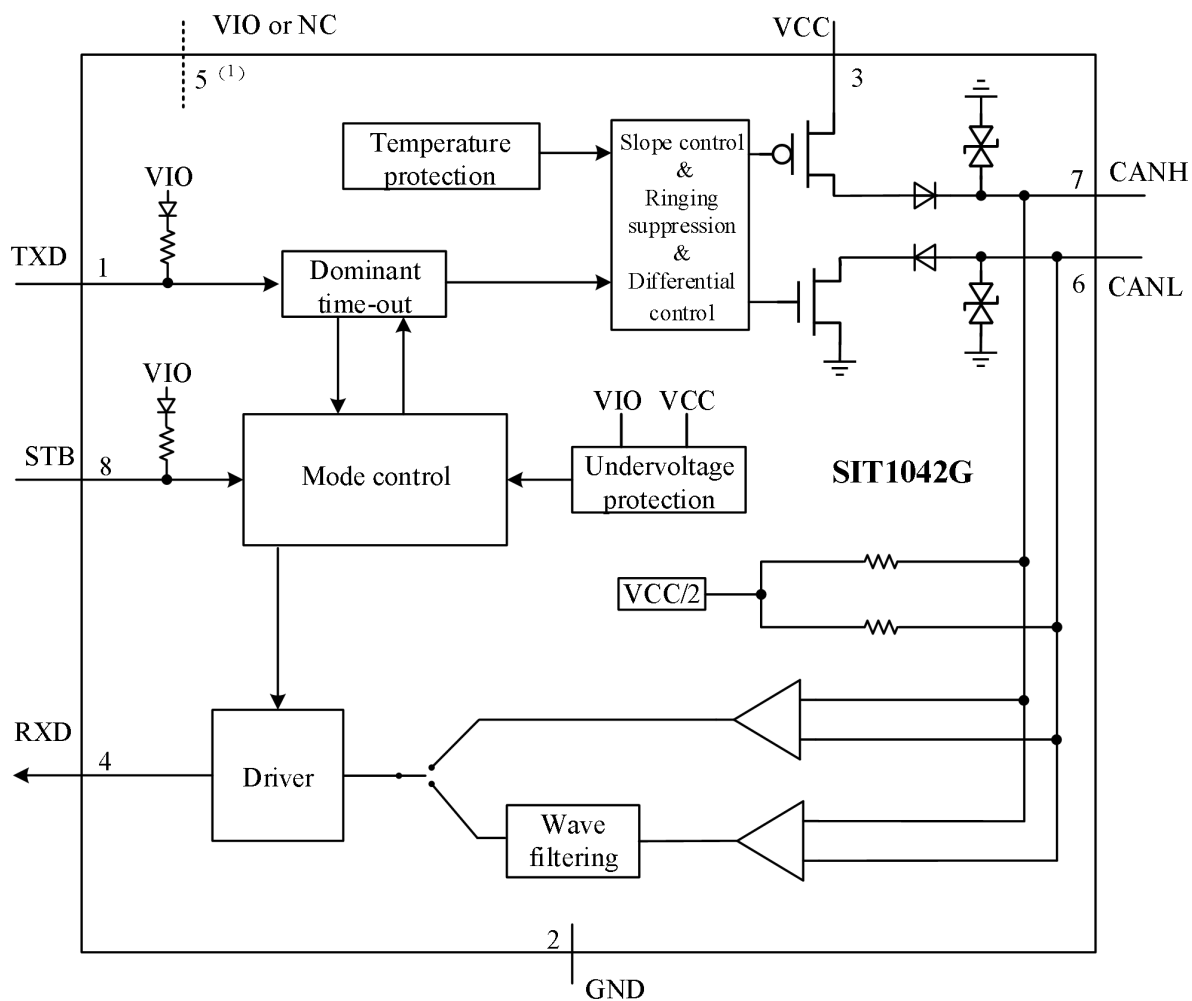


## PIN DESCRIPTION

| PIN | SYMBOL | DESCRIPTION                                                                                  |
|-----|--------|----------------------------------------------------------------------------------------------|
| 1   | TXD    | transmit data input                                                                          |
| 2   | GND    | ground                                                                                       |
| 3   | VCC    | supply voltage                                                                               |
| 4   | RXD    | receive data output                                                                          |
| 5   | VIO    | transceiver I/O level conversion power supply voltage (SIT1042GT/3 and SIT1042GTK/3 version) |
| 5   | NC     | Not connected in SIT1042GT version                                                           |
| 6   | CANL   | LOW-level CAN-bus line                                                                       |
| 7   | CANH   | HIGH-level CAN-bus line                                                                      |
| 8   | STB    | standby mode control input, low level is high speed mode                                     |

Note: The metal pad on the back of the DFN3\*3-8 package is recommended to be grounded.

# INTERNAL CIRCUIT BLOCK DIAGRAM



(1) VIO is only available in SIT1042GT/3 and SIT1042GTK/3 version, pin 5 is not connected in SIT1042GT version.

## LIMITING VALUES

| PARAMETER                          | SYMBOL                      | CONDITIONS                                                                       | VALUE   | UNIT |
|------------------------------------|-----------------------------|----------------------------------------------------------------------------------|---------|------|
| Supply voltage                     | $V_{CC}, V_{IO}$            | pins VCC, VIO                                                                    | -0.3~+7 | V    |
| MCU side port                      | $V_{TXD}, V_{RXD}, V_{STB}$ | pins TXD, RXD, STB                                                               | -0.3~+7 | V    |
| Bus side input voltage             | $V_{CANH}, V_{CANL}$        | pins CANH, CANL                                                                  | -58~+58 | V    |
| Bus differential breakdown voltage | $V_{CANH-CANL}$             |                                                                                  | -58~+58 | V    |
| Electrostatic discharge voltage    | $V_{ESD}$                   | IEC 61000-4-2: on pins CANH, CANL                                                | ±10     | kV   |
|                                    |                             | Human-body model (HBM), per AEC Q100-002: all pins                               | ±4      | kV   |
|                                    |                             | Human-body model (HBM), per AEC Q100-002: pins CANH and CANL with respect to GND | ±6      | kV   |
|                                    |                             | Charged Device Model (CDM): all pins                                             | ±2000   | V    |
| Transient voltage                  | $V_{trt}$                   | Pulse 1                                                                          | -100    | V    |
|                                    |                             | Pulse 2a                                                                         | 75      | V    |
|                                    |                             | Pulse 3a                                                                         | -150    | V    |
|                                    |                             | Pulse 3b                                                                         | 100     | V    |
| Storage temperature                | $T_{stg}$                   |                                                                                  | -55~150 | °C   |
| Virtual junction temperature       | $T_j$                       |                                                                                  | -40~150 | °C   |

The maximum limit parameters mean that exceeding these values may cause irreversible damage to the device. Under these conditions, it is not conducive to the normal operation of the device. The continuous operation of the device at the maximum allowable rating may affect the reliability of the device. The reference point for all voltages is ground.

## THERMAL CHARACTERISTICS

| PARAMETER       | SYMBOL                                 | CONDITIONS | VALUE | UNIT |
|-----------------|----------------------------------------|------------|-------|------|
| $R_{\theta JA}$ | Junction-to-ambient thermal resistance | SOP8       | 95    | °C/W |
|                 |                                        | DFN3*3-8   | 65    | °C/W |
| $R_{\theta JC}$ | Junction-to-case thermal resistance    | SOP8       | 46    | °C/W |
|                 |                                        | DFN3*3-8   | 35    | °C/W |

## DRIVER ELECTRICAL CHARACTERISTICS

| PARAMETER                                                    | SYMBOL                       | CONDITIONS                                                                                                                    | MIN.        | TYP.        | MAX.        | UNIT |
|--------------------------------------------------------------|------------------------------|-------------------------------------------------------------------------------------------------------------------------------|-------------|-------------|-------------|------|
| CANH dominant output voltage                                 | $V_{OH(D)}$                  | Normal mode, $V_{TXD}=0V$ ,<br>$R_L=50\Omega$ to $65\Omega$                                                                   | 2.75        | 3.5         | 4.5         | V    |
| CANL dominant output voltage                                 | $V_{OL(D)}$                  |                                                                                                                               | 0.5         | 1.5         | 2.25        | V    |
| Bus dominant differential output voltage                     | $V_{OD(D)}$                  | Normal mode, $V_{TXD}=0V$ ,<br>$R_L=50\Omega$ to $65\Omega$                                                                   | 1.5         | -           | 3           | V    |
|                                                              |                              | Normal mode, $V_{TXD}=0V$ ,<br>$R_L=45\Omega$ to $70\Omega$                                                                   | 1.4         | -           | 3.3         | V    |
|                                                              |                              | Normal mode, $V_{TXD}=0V$ ,<br>$R_L=2240\Omega$                                                                               | 1.5         | -           | 5           | V    |
| Bus recessive output voltage                                 | $V_{O(R)}$                   | Normal mode, $V_{TXD}=V_{IO}$ ,<br>No load                                                                                    | 2           | $0.5V_{CC}$ | 3           | V    |
|                                                              |                              | Normal mode, $V_{TXD}=V_{IO}$ ,<br>$R_L=60\Omega$                                                                             | 2.2         | $0.5V_{CC}$ | 2.8         | V    |
| Bus recessive differential output voltage                    | $V_{OD(R)}$                  | Normal mode, $V_{TXD}=V_{IO}$ ,<br>No load                                                                                    | -50         | -           | 50          | mV   |
|                                                              |                              | Normal mode, $V_{TXD}=V_{IO}$ ,<br>$R_L=60\Omega$                                                                             | -50         | -           | 50          | mV   |
| Bus output voltage<br>(Bus is biased to ground)              | $V_{O(S)}$                   | Standby mode, No load                                                                                                         | -0.1        | -           | 0.1         | V    |
| Bus differential output voltage<br>(Bus is biased to ground) | $V_{OD(S)}$                  | Standby mode, No load                                                                                                         | -0.2        | -           | 0.2         | V    |
| Transmitter dominant voltage symmetry                        | $V_{dom(TX)sym}$             | $V_{dom(TX)sym}=V_{CC}-V_{CANH}-V_{CANL}$                                                                                     | -400        | -           | 400         | mV   |
| Transmitter voltage symmetry                                 | $V_{TXsym}$ <sup>(1)</sup>   | $V_{TXsym}=V_{CANH}+V_{CANL}$ ,<br>$R_L=60\Omega$ , $C_{SPLIT}=4.7nF$ ,<br>$f_{TXD}=250kHz$ , 1MHz, 2.5MHz<br><b>Figure 5</b> | $0.9V_{CC}$ | -           | $1.1V_{CC}$ | V    |
| Dominant-recessive common-mode output voltage difference     | $V_{cm(step)}$               | <b>Figure 3 &amp; Figure 5</b>                                                                                                | -150        | -           | 150         | mV   |
| Dominant-recessive common-mode peak-to-peak                  | $V_{cm(p-p)}$ <sup>(1)</sup> | <b>Figure 3 &amp; Figure 5</b>                                                                                                | -300        | -           | 300         | mV   |

| PARAMETER                              | SYMBOL         | CONDITIONS                                                        | MIN. | TYP. | MAX. | UNIT |
|----------------------------------------|----------------|-------------------------------------------------------------------|------|------|------|------|
| Dominant Short-circuit output current  | $I_{O(SC)DOM}$ | Normal mode, $V_{TXD}=0V$ , $V_{CANH}=-15V$ to $40V$              | -100 | -    | -    | mA   |
|                                        |                | Normal mode, $V_{TXD}=0V$ , $V_{CANL}=-15V$ to $40V$              | -    | -    | 100  | mA   |
| Recessive Short-circuit output current | $I_{O(SC)REC}$ | Normal mode, $V_{TXD}=V_{IO}$ , $V_{CANH}=V_{CANL}=-27V$ to $32V$ | -3   | -    | 3    | mA   |

Unless otherwise stated, all typical values are measured at 25°C, supply voltage  $V_{CC}=5V$ ,  $V_{IO}=5V$  (if applicable),  $R_L=60\Omega$ .

(1) Not tested in production, guaranteed by design.

## DRIVER SWITCHING CHARACTERISTICS

| PARAMETER                                        | SYMBOL              | CONDITIONS                                  | MIN. | TYP. | MAX. | UNIT |
|--------------------------------------------------|---------------------|---------------------------------------------|------|------|------|------|
| Propagation delay time, low-to-high level output | $t_{d(TXD-busdom)}$ | Normal mode, <b>Figure 1 &amp; Figure 4</b> | -    | -    | 80   | ns   |
| Propagation delay time, high-to-low level output | $t_{d(TXD-busrec)}$ | Normal mode, <b>Figure 1 &amp; Figure 4</b> | -    | -    | 80   | ns   |
| Differential output signal rise time             | $t_r(BUS)$          |                                             | -    | 30   | -    | ns   |
| Differential output signal fall time             | $t_f(BUS)$          |                                             | -    | 30   | -    | ns   |

Unless otherwise stated, all typical values are measured at 25°C, supply voltage  $V_{CC}=5V$ ,  $V_{IO}=5V$  (if applicable),  $R_L=60\Omega$ .

## RECEIVER ELECTRICAL CHARACTERISTICS

| PARAMETER                                   | SYMBOL           | CONDITIONS                          | MIN. | TYP. | MAX. | UNIT |
|---------------------------------------------|------------------|-------------------------------------|------|------|------|------|
| Receiver threshold voltage                  | $V_{th(RX)dif}$  | Normal mode, $-30V < V_{CM} < 30V$  | 0.5  | -    | 0.9  | V    |
|                                             |                  | Standby mode, $-12V < V_{CM} < 12V$ | 0.4  | -    | 1.1  | V    |
| Receiver threshold voltage hysteresis range | $V_{hys(RX)dif}$ | Normal mode, $-30V < V_{CM} < 30V$  | -    | 80   | -    | mV   |
| Receiver recessive voltage range            | $V_{rec(RX)}$    | Normal mode, $-30V < V_{CM} < 30V$  | -3   | -    | 0.5  | V    |
|                                             |                  | Standby mode, $-12V < V_{CM} < 12V$ | -3   | -    | 0.4  | V    |

| PARAMETER                                 | SYMBOL                 | CONDITIONS                                                                                                                           | MIN. | TYP. | MAX. | UNIT             |
|-------------------------------------------|------------------------|--------------------------------------------------------------------------------------------------------------------------------------|------|------|------|------------------|
| Receiver dominant voltage range           | $V_{\text{dom(RX)}}$   | Normal mode,<br>$-30\text{V} < V_{\text{CM}} < 30\text{V}$                                                                           | 0.9  | -    | 8    | V                |
|                                           |                        | Standby mode,<br>$-12\text{V} < V_{\text{CM}} < 12\text{V}$                                                                          | 1.1  | -    | 8    | V                |
| Bus leakage current                       | $I_{\text{L}}$         | $V_{\text{CC}}=V_{\text{IO}}=0\text{V}$ ,<br>$V_{\text{CANH}}=V_{\text{CANL}}=5\text{V}$ ,<br>$T_{\text{amb}} < 105^{\circ}\text{C}$ | -10  | -    | 10   | $\mu\text{A}$    |
| CANH, CANL input resistance               | $R_{\text{IN}}$        | $-2\text{V} \leq V_{\text{CANH}} \leq 7\text{V}$<br>$-2\text{V} \leq V_{\text{CANL}} \leq 7\text{V}$                                 | 25   | 40   | 50   | $\text{k}\Omega$ |
| CANH, CANL differential-input resistance  | $R_{\text{ID}}$        | $-2\text{V} \leq V_{\text{CANH}} \leq 7\text{V}$<br>$-2\text{V} \leq V_{\text{CANL}} \leq 7\text{V}$                                 | 50   | 80   | 100  | $\text{k}\Omega$ |
| CANH, CANL input resistance mismatch      | $\Delta R_{\text{IN}}$ | $0\text{V} \leq V_{\text{CANH}} \leq 5\text{V}$<br>$0\text{V} \leq V_{\text{CANL}} \leq 5\text{V}$                                   | -2   | -    | 2    | %                |
| CANH, CANL input capacitance to ground    | $C_{\text{IN}}$ (1)    | $V_{\text{TXD}}=V_{\text{IO}}$                                                                                                       | -    | -    | 40   | pF               |
| CANH, CANL differential-input capacitance | $C_{\text{ID}}$ (1)    | $V_{\text{TXD}}=V_{\text{IO}}$                                                                                                       | -    | -    | 20   | pF               |
| Slew Rate                                 | SR (1)                 | <b>Figure 4</b>                                                                                                                      | -    | -    | 70   | V/ $\mu\text{s}$ |

Unless otherwise stated, all typical values are measured at 25°C, supply voltage  $V_{\text{CC}}=5\text{V}$ ,  $V_{\text{IO}}=5\text{V}$  (if applicable),  $R_{\text{L}}=60\Omega$ .

(1) Not tested in production, guaranteed by design.

## RECEIVER SWITCHING CHARACTERISTICS

| PARAMETER                                        | SYMBOL                     | CONDITIONS                                     | MIN. | TYP. | MAX. | UNIT |
|--------------------------------------------------|----------------------------|------------------------------------------------|------|------|------|------|
| Propagation delay time, low-to-high level output | $t_{\text{d(busdom-RXD)}}$ | Normal mode,<br><b>Figure 1 &amp; Figure 4</b> | -    | -    | 110  | ns   |
| Propagation delay time, low-to-high level output | $t_{\text{d(busrec-RXD)}}$ | Normal mode,<br><b>Figure 1 &amp; Figure 4</b> | -    | -    | 110  | ns   |
| RXD signal rise time                             | $t_{\text{r(RXD)}}$        |                                                | -    | 8    | -    | ns   |
| RXD signal fall time                             | $t_{\text{f(RXD)}}$        |                                                | -    | 8    | -    | ns   |

Unless otherwise stated, all typical values are measured at 25°C, supply voltage  $V_{\text{CC}}=5\text{V}$ ,  $V_{\text{IO}}=5\text{V}$  (if applicable),  $R_{\text{L}}=60\Omega$ .

## DEVICE SWITCHING CHARACTERISTICS

| PARAMETER                                          | SYMBOL                | CONDITIONS                                                          | MIN. | TYP. | MAX. | UNIT |
|----------------------------------------------------|-----------------------|---------------------------------------------------------------------|------|------|------|------|
| Loop delay 1, TXD falling edge to RXD falling edge | $t_{loop1}$           | Normal mode,<br><b>Figure 1 &amp; Figure 4</b>                      | 40   | -    | 190  | ns   |
| Loop delay 2, TXD rising edge to RXD rising edge   | $t_{loop2}$           | Normal mode,<br><b>Figure 1 &amp; Figure 4</b>                      | 40   | -    | 190  | ns   |
| Transmitted recessive bit width deviation          | $\Delta t_{bit(BUS)}$ | According to ISO 11898-2:2024 set B, <b>Figure 2 &amp; Figure 4</b> |      |      |      |      |
|                                                    |                       | $\Delta t_{bit(BUS)} = t_{bit(BUS)} - t_{bit(TXD)}$                 | -45  | -    | 10   | ns   |
|                                                    |                       | According to ISO 11898-2:2024 set C, <b>Figure 2 &amp; Figure 4</b> |      |      |      |      |
|                                                    |                       | $\Delta t_{bit(BUS)} = t_{bit(BUS)} - t_{bit(TXD)}$                 | -10  | -    | 10   | ns   |
| Receiver timing symmetry                           | $\Delta t_{rec}$      | According to ISO 11898-2:2024 set B, <b>Figure 2 &amp; Figure 4</b> |      |      |      |      |
|                                                    |                       | $\Delta t_{rec} = t_{bit(RXD)} - t_{bit(BUS)}$                      | -45  | -    | 15   | ns   |
|                                                    |                       | According to ISO 11898-2:2024 set C, <b>Figure 2 &amp; Figure 4</b> |      |      |      |      |
|                                                    |                       | $\Delta t_{rec} = t_{bit(RXD)} - t_{bit(BUS)}$                      | -20  | -    | 15   | ns   |
| Received recessive bit width deviation             | $\Delta t_{bit(RXD)}$ | According to ISO 11898-2:2024 set C, <b>Figure 2 &amp; Figure 4</b> |      |      |      |      |
|                                                    |                       | $\Delta t_{bit(RXD)} = t_{bit(RXD)} - t_{bit(TXD)}$                 | -80  | -    | 20   | ns   |
|                                                    |                       | According to ISO 11898-2:2024 set B, <b>Figure 2 &amp; Figure 4</b> |      |      |      |      |
|                                                    |                       | $\Delta t_{bit(RXD)} = t_{bit(RXD)} - t_{bit(TXD)}$                 | -30  | -    | 20   | ns   |
| TXD dominant timeout                               | $t_{dom(TXD)}$        |                                                                     | 0.8  | 2    | 6    | ms   |
| BUS dominant timeout                               | $t_{dom(BUS)}$        |                                                                     | 0.8  | 2    | 6    | ms   |
| Enable time from standby mode to normal mode       | $t_{mode}$            |                                                                     | -    | -    | 10   | μs   |
| Bus dominant wake-up filter time                   | $t_{wake(dom)}$       |                                                                     | 0.5  | -    | 1.8  | μs   |
| Bus recessive wake-up filter time                  | $t_{wake(rec)}$       |                                                                     | 0.5  | -    | 1.8  | μs   |

Unless otherwise stated, all typical values are measured at 25°C, supply voltage  $V_{CC}=5V$ ,  $V_{IO}=5V$  (if applicable),  $R_L=60\Omega$ .

(1) Not tested in production, guaranteed by design.

## TXD PIN CHARACTERISTICS

| PARAMETER                            | SYMBOL       | CONDITIONS                             | MIN. | TYP. | MAX. | UNIT |
|--------------------------------------|--------------|----------------------------------------|------|------|------|------|
| Leakage current of TXD without power | $I_{O(off)}$ | $V_{CC}=V_{IO}=0V$ ,<br>$V_{TXD}=5.5V$ | -1   | -    | 1    | μA   |

| PARAMETER                | SYMBOL           | CONDITIONS                  | MIN.        | TYP. | MAX.         | UNIT  |
|--------------------------|------------------|-----------------------------|-------------|------|--------------|-------|
| HIGH-level input voltage | $V_{IH}$         | SIT1042GT/3<br>SIT1042GTK/3 | $0.7V_{IO}$ | -    | $V_{IO}+0.3$ | V     |
| LOW-level input voltage  | $V_{IL}$         | SIT1042GT/3<br>SIT1042GTK/3 | -0.3        | -    | $0.3V_{IO}$  | V     |
| HIGH-level input voltage | $V_{IH}$         | SIT1042GT                   | 2           | -    | $V_{CC}+0.3$ | V     |
| LOW-level input voltage  | $V_{IL}$         | SIT1042GT                   | -0.3        | -    | 0.8          | V     |
| Pull-up resistance       | $R_{pu}$         | $2.8V < V_{IO} < 5.5V$      | 20          | -    | 80           | kΩ    |
| Open voltage on TXD pin  | TXD <sub>O</sub> |                             | H           |      |              | logic |

Unless otherwise stated, all typical values are measured at 25°C, supply voltage  $V_{CC}=5V$ ,  $V_{IO}=5V$  (if applicable),  $R_L=60\Omega$ .

## STB PIN CHARACTERISTICS

| PARAMETER                            | SYMBOL           | CONDITIONS                             | MIN.        | TYP. | MAX.         | UNIT  |
|--------------------------------------|------------------|----------------------------------------|-------------|------|--------------|-------|
| Leakage current of STB without power | $I_{O(off)}$     | $V_{CC}=V_{IO}=0V$ ,<br>$V_{STB}=5.5V$ | -1          | -    | 1            | μA    |
| HIGH-level input voltage             | $V_{IH}$         | SIT1042GT/3<br>SIT1042GTK/3            | $0.7V_{IO}$ | -    | $V_{IO}+0.3$ | V     |
| LOW-level input voltage              | $V_{IL}$         | SIT1042GT/3<br>SIT1042GTK/3            | -0.3        | -    | $0.3V_{IO}$  | V     |
| HIGH-level input voltage             | $V_{IH}$         | SIT1042GT                              | 2           | -    | $V_{CC}+0.3$ | V     |
| LOW-level input voltage              | $V_{IL}$         | SIT1042GT                              | -0.3        | -    | 0.8          | V     |
| Pull-up resistance                   | $R_{pu}$         | $2.8V < V_{IO} < 5.5V$                 | 20          | -    | 80           | kΩ    |
| Open voltage on STB pin              | STB <sub>O</sub> |                                        | H           |      |              | logic |

Unless otherwise stated, all typical values are measured at 25°C, supply voltage  $V_{CC}=5V$ ,  $V_{IO}=5V$  (if applicable),  $R_L=60\Omega$ .

## RXD PIN CHARACTERISTICS

| PARAMETER                            | SYMBOL        | CONDITIONS                               | MIN. | TYP. | MAX. | UNIT |
|--------------------------------------|---------------|------------------------------------------|------|------|------|------|
| HIGH-level output current            | $I_{OH}(RXD)$ | $V_{RXD}=V_{IO}-0.4V$ ,<br>Bus recessive | -10  | -5   | -1   | mA   |
| LOW-level output current             | $I_{OL}(RXD)$ | $V_{RXD}=0.4V$ ,<br>Bus dominant         | 1    | 5    | 10   | mA   |
| Leakage current of RXD without power | $I_{O(off)}$  | $V_{CC}=V_{IO}=0V$ , $V_{RXD}=5.5V$      | -5   | -    | 5    | μA   |

Unless otherwise stated, all typical values are measured at 25°C, supply voltage  $V_{CC}=5V$ ,  $V_{IO}=5V$  (if applicable),  $R_L=60\Omega$ .

## SUPPLY CURRENT

| PARAMETER          | SYMBOL                | CONDITIONS                                                                                               | MIN. | TYP. | MAX. | UNIT |
|--------------------|-----------------------|----------------------------------------------------------------------------------------------------------|------|------|------|------|
| VCC supply current | I <sub>CC_DOM</sub>   | Normal mode, dominant                                                                                    | -    | 42   | 70   | mA   |
|                    | I <sub>CC_REC</sub>   | Normal mode, recessive                                                                                   | -    | 5    | 10   | mA   |
|                    | I <sub>CC_DOM_S</sub> | Dominant;<br>short circuit on bus lines;<br>-3V<(V <sub>CANH</sub> =V <sub>CANL</sub> )<40V              | -    | -    | 109  | mA   |
|                    | I <sub>CC_STB</sub>   | Standby mode, V <sub>STB</sub> =V <sub>TXD</sub> =V <sub>IO</sub> ,<br>(SIT1042GT/3 and<br>SIT1042GTK/3) | -    | -    | 4    | μA   |
|                    | I <sub>CC_STB</sub>   | Standby mode,<br>V <sub>STB</sub> =V <sub>TXD</sub> =V <sub>CC</sub> ,<br>(SIT1042GT)                    | -    | -    | 26   | μA   |
| VIO supply current | I <sub>IO_DOM</sub>   | Normal mode, dominant                                                                                    | -    | 240  | 420  | μA   |
|                    | I <sub>IO_REC</sub>   | Normal mode, recessive                                                                                   | -    | 120  | 240  | μA   |
|                    | I <sub>IO_STB</sub>   | Standby mode,<br>V <sub>STB</sub> =V <sub>TXD</sub> =V <sub>IO</sub>                                     | -    | 12   | 24   | μA   |

Unless otherwise stated, all typical values are measured at 25°C, supply voltage V<sub>CC</sub>=5V, V<sub>IO</sub>=5V (if applicable), R<sub>L</sub>=60Ω.

## OVER TEMPERATURE PROTECTION

| PARAMETER                     | SYMBOL                            | CONDITIONS | MIN. | TYP. | MAX. | UNIT |
|-------------------------------|-----------------------------------|------------|------|------|------|------|
| Shutdown junction temperature | T <sub>j(sd)</sub> <sup>(1)</sup> |            | -    | 190  | -    | °C   |

Unless otherwise stated, all typical values are measured at 25°C, supply voltage V<sub>CC</sub>=5V, V<sub>IO</sub>=5V (if applicable), R<sub>L</sub>=60Ω.

(1) Not tested in production, guaranteed by design.

## UNDERVOLTAGE PROTECTION

| PARAMETER                   | SYMBOL               | CONDITIONS | MIN. | TYP. | MAX. | UNIT |
|-----------------------------|----------------------|------------|------|------|------|------|
| VCC undervoltage protection | V <sub>UVD_VCC</sub> |            | 3.7  | -    | 4.3  | V    |
| VIO undervoltage protection | V <sub>UVD_VIO</sub> |            | 1.4  | -    | 1.65 | V    |

Unless otherwise stated, all typical values are measured at 25°C, supply voltage V<sub>CC</sub>=5V, V<sub>IO</sub>=5V (if applicable), R<sub>L</sub>=60Ω.

**FUNCTION TABLE**
**Table 1 CAN TRANSCEIVER TRUTH TABLE**

| TXD <sup>(1)</sup> | STB <sup>(1)</sup> | CANH <sup>(1)</sup> | CANL <sup>(1)</sup> | BUS STATE | RXD <sup>(1)</sup> |
|--------------------|--------------------|---------------------|---------------------|-----------|--------------------|
| L                  | L                  | H                   | L                   | Dominate  | L                  |
| H or Open          | L                  | 0.5V <sub>CC</sub>  | 0.5V <sub>CC</sub>  | Recessive | H                  |
| X                  | H or Open          | GND                 | GND                 | Recessive | H                  |

(1) H=high level; L=low level; X=irrelevant.

**Table 2 RECEIVER FUNCTION TABLE**

| OPERATING MODE | V <sub>ID</sub> =V <sub>CANH</sub> -V <sub>CANL</sub> | BUS STATE | RXD <sup>(1)</sup> |
|----------------|-------------------------------------------------------|-----------|--------------------|
| Normal mode    | V <sub>ID</sub> ≥0.9V                                 | Dominate  | L                  |
|                | 0.5<V <sub>ID</sub> <0.9V                             | ?         | ?                  |
|                | V <sub>ID</sub> ≤0.5V                                 | Recessive | H                  |
| Standby mode   | V <sub>ID</sub> ≥1.1V                                 | Dominate  | L                  |
|                | 0.4<V <sub>ID</sub> <1.1V                             | ?         | ?                  |
|                | V <sub>ID</sub> ≤0.4V                                 | Recessive | H                  |

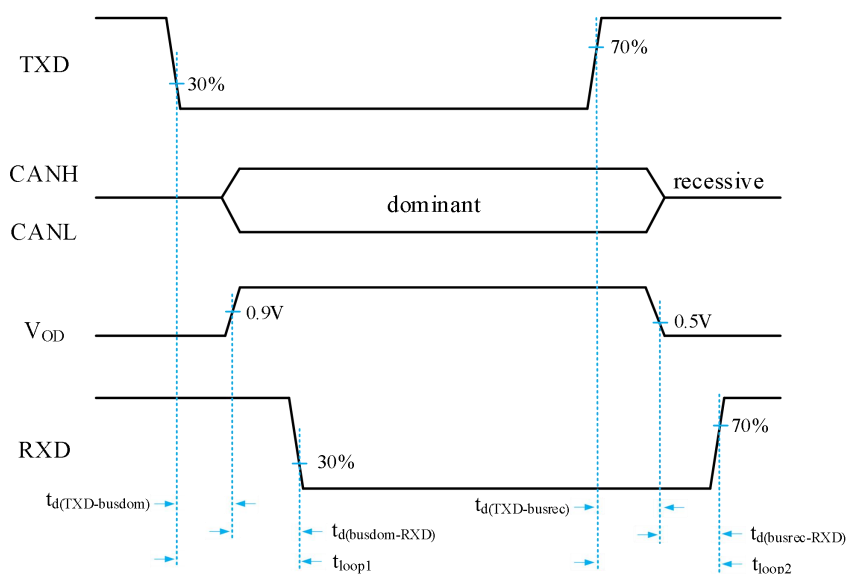
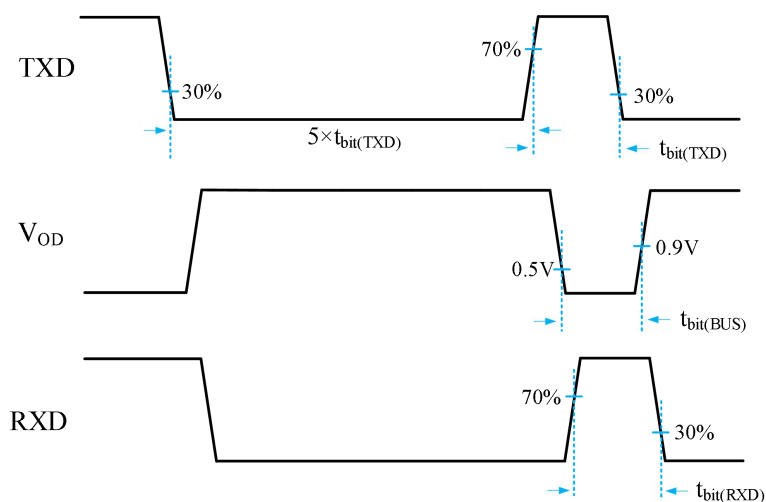
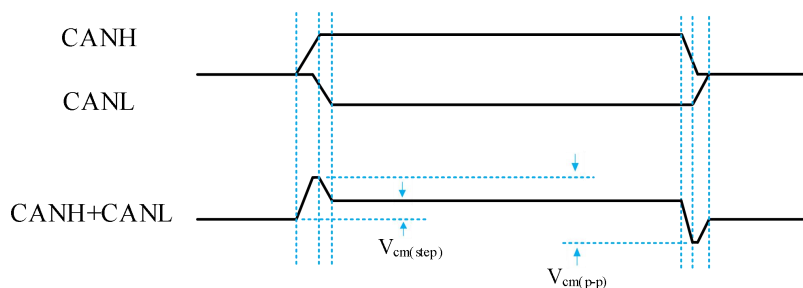
(1) H=high level; L=low level; ?=uncertain.

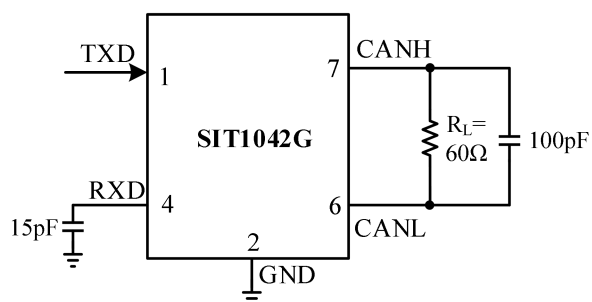
**Table 3 UNDERVOLTAGE PROTECTION STATUS TABLE**

| VCC                                   | VIO <sup>(1)</sup>                    | BUS STATE        | BUS OUTPUT <sup>(2)</sup> | RXD <sup>(2)</sup> |
|---------------------------------------|---------------------------------------|------------------|---------------------------|--------------------|
| V <sub>CC</sub> >V <sub>uvd_VCC</sub> | V <sub>IO</sub> >V <sub>uvd_VIO</sub> | Normal           | According to STB and TXD  | Follow the bus     |
| V <sub>CC</sub> <V <sub>uvd_VCC</sub> | V <sub>IO</sub> >V <sub>uvd_VIO</sub> | Protected status | GND                       | H                  |
| V <sub>CC</sub> >V <sub>uvd_VCC</sub> | V <sub>IO</sub> <V <sub>uvd_VIO</sub> | Protected status | Z                         | Z                  |
| V <sub>CC</sub> <V <sub>uvd_VCC</sub> | V <sub>IO</sub> <V <sub>uvd_VIO</sub> | Protected status | Z                         | Z                  |

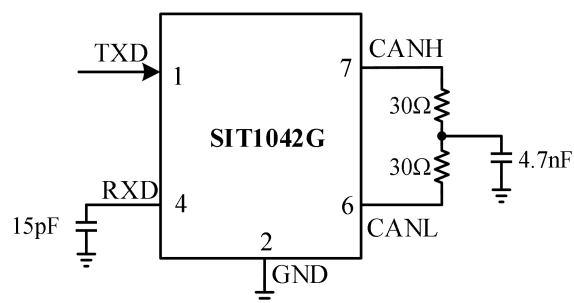
(1) SIT1042GT/3 and SIT1042GTK/3 version only;

(2) H=high level; Z=high ohmic.

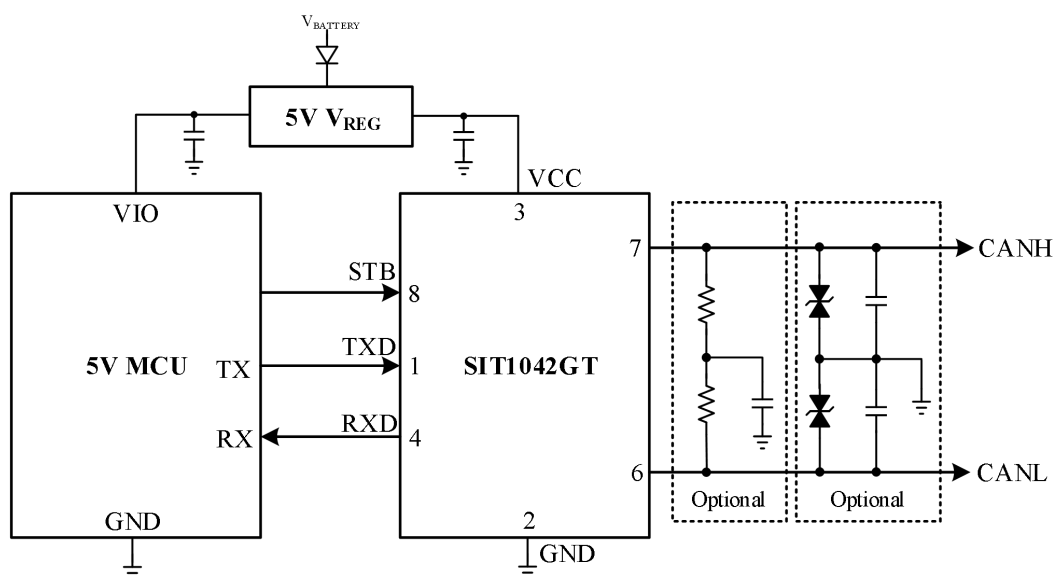
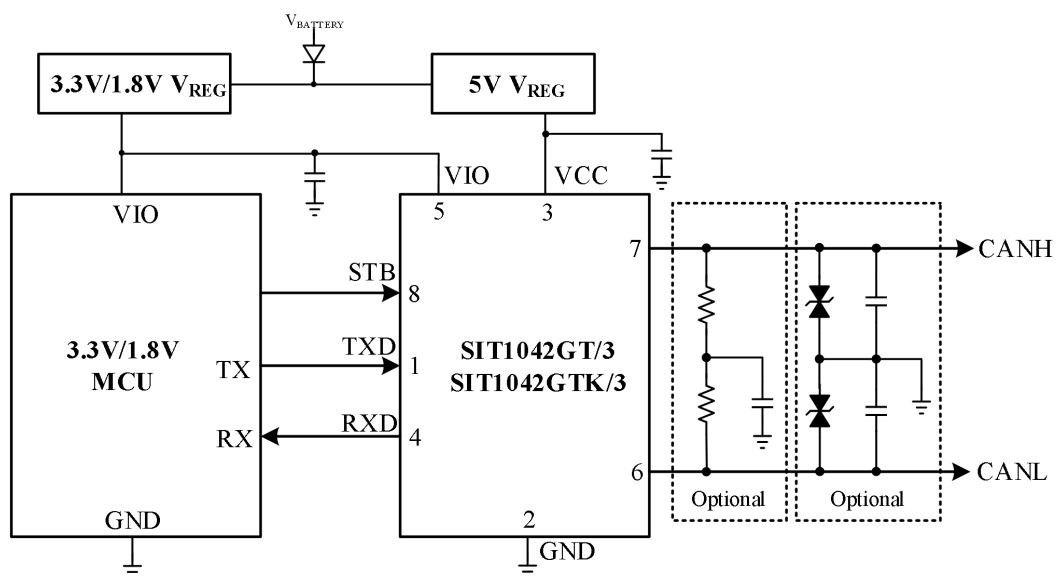
**TIMING WAVEFORM**

**Figure 1 Transceiver transmission delay**

**Figure 2  $t_{bit}$  delay**

**Figure 3 Bus common-mode voltage (SAE 1939-14)**

**TEST CIRCUIT**


**Figure 4** Transceiver timing sequence test circuit



**Figure 5** Transceiver bus symmetry test circuit

**TYPICAL APPLICATION DIAGRAM**

**Figure 6 SIT1042GT and 5V MCU typical application diagram**

**Figure 7 SIT1042GT/3, SIT1042GTK/3 and 1.8V/3.3V MCU typical application diagram**

**ADDITIONAL DESCRIPTION****1 Sketch**

SIT1042G is an interface chip applied between the CAN protocol controller and the physical bus. It can be used for industrial control and other fields. It supports 8Mbps flexible data rate (CAN FD) and has the ability to transmit differential signals between the bus and the CAN protocol controller. Fully compatible with ISO 11898-2:2024 standard.

**2 Short-circuit protection**

A current-limiting circuit protects the transmitter output stage from damage caused by accidental short-circuit to either positive or negative supply voltage, although power dissipation increases during this fault condition.

**3 Over temperature protection**

The SIT1042G features over-temperature protection functionality. When triggered, the current at the driver stage will be reduced since the driver transistor is the primary power-consuming component. This current reduction helps decrease power consumption and consequently lowers the chip temperature. Meanwhile, all other sections of the chip remain fully operational.

**4 Undervoltage protection**

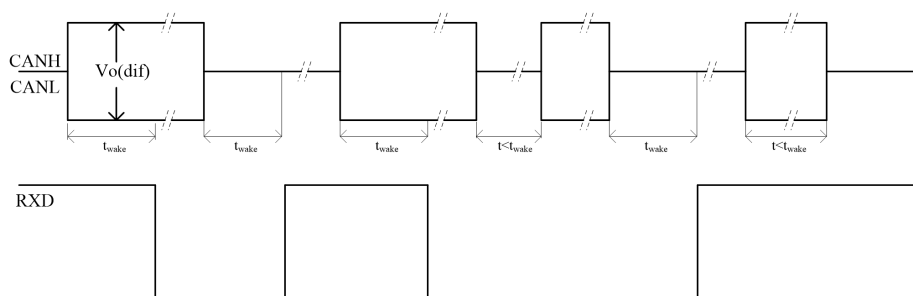
The SIT1042G power supply pin has an undervoltage detection function, which can put the device in a protected mode. This protects the bus when  $V_{CC}$  is lower than  $V_{uvd\_VCC}$  or  $V_{IO}$  is lower than  $V_{uvd\_VIO}$  (if applicable).

**5 Control mode**

The SIT1042G provides two modes of operation which are selectable via pin STB: High-speed mode and standby mode.

High-speed mode is the normal operating mode, selected by grounding the STB pin. Both the CAN driver and receiver operate fully normally, enabling bidirectional CAN communication.

Set pin STB to high level or floating to activate low-power standby mode. Both CAN driver and receiver are shut down to reduce system power consumption. Standby mode activates a low-power receiver and wake-up filter; once the low-power receiver detects a dominant bus level exceeding  $t_{wake}$ , pin RXD will follow the bus. (In SIT1042GT/3 and SIT1042GTK/3 the low-power receiver can still detect dominant/recessive levels on the bus even when  $V_{CC}$  is undervoltage or floating, as long as  $V_{IO}$  is normally powered.)



**Figure 8 Wake-up timing**

## 6 TXD dominant time-out function

A ‘TXD dominant time-out’ timer circuit prevents the bus lines from being driven to a permanent dominant state (blocking all network communication) if pin TXD is forced permanently LOW by a hardware and/or software application failure. The timer is triggered by a falling edge on pin TXD.

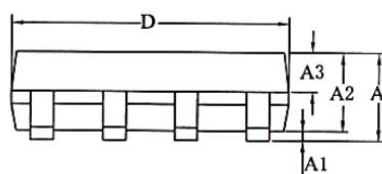
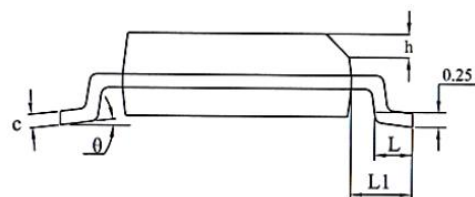
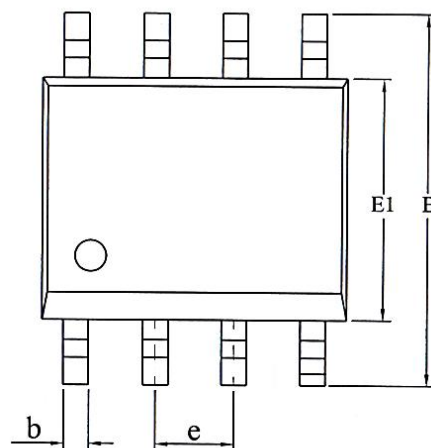
If the duration of the LOW level on pin TXD exceeds the internal timer value ( $t_{dom}$ ), the transmitter is disabled, driving the bus lines into a recessive state. The timer is reset by a rising edge on pin TXD.

In standby mode, the pin RXD is forced to high if the bus becomes dominant and lasts longer than ( $t_{dom\_BUS}$ ), which can prevent permanent wakeup due to a short circuit in the bus or the failure of another node on the network. It can be reset when the bus changes from dominant to recessive.

## SOP8 DIMENSIONS

### PACKAGE SIZE

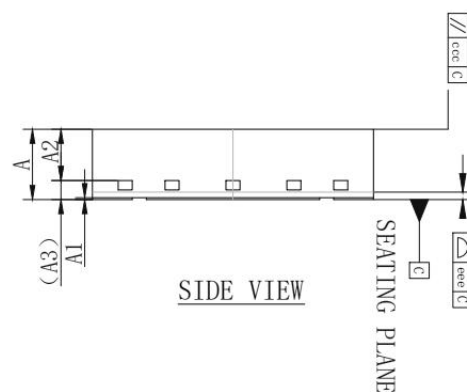
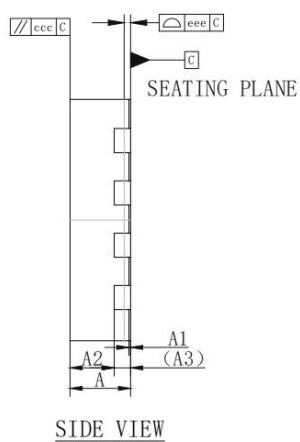
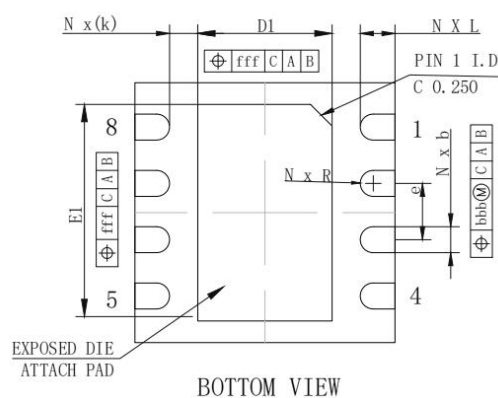
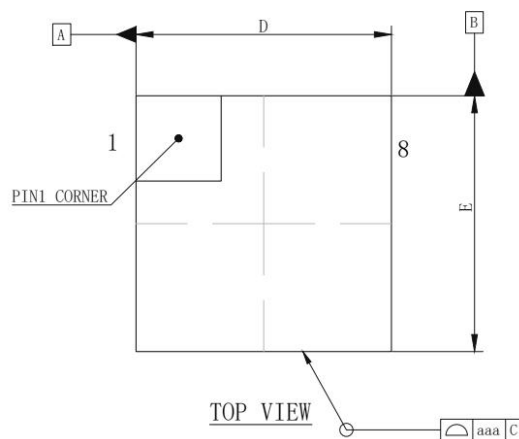
| SYMBOL | MIN./mm | TYP./mm | MAX./mm |
|--------|---------|---------|---------|
| A      | 1.40    | -       | 1.80    |
| A1     | 0.10    | -       | 0.25    |
| A2     | 1.30    | 1.40    | 1.50    |
| A3     | 0.60    | 0.65    | 0.70    |
| b      | 0.38    | -       | 0.51    |
| D      | 4.80    | 4.90    | 5.00    |
| E      | 5.80    | 6.00    | 6.20    |
| E1     | 3.80    | 3.90    | 4.00    |
| e      | 1.27BSC |         |         |
| L      | 0.40    | 0.60    | 0.80    |
| L1     | 1.05REF |         |         |
| c      | 0.20    | -       | 0.25    |
| θ      | 0°      | -       | 8°      |



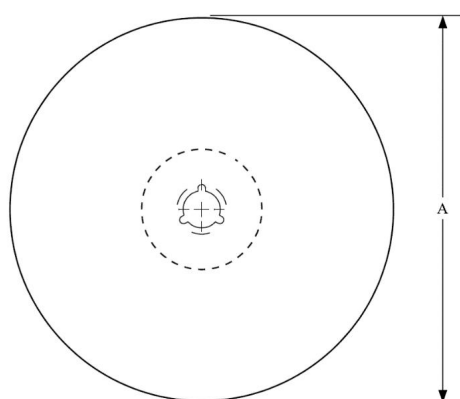
### DFN3\*3-8 DIMENSIONS

## PACKAGE SIZE

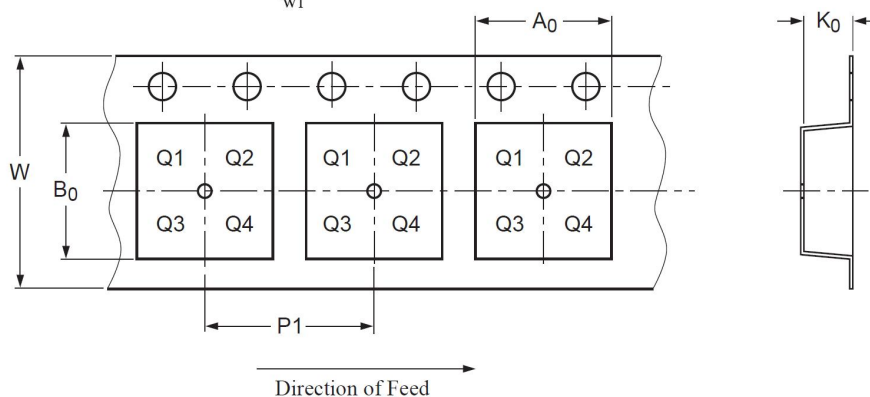
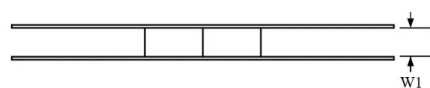
| SYMBOL | MIN/mm    | TYP /mm | MAX/mm |
|--------|-----------|---------|--------|
| D      | 2.900     | 3.000   | 3.100  |
| E      | 2.900     | 3.000   | 3.100  |
| E1     | 1.450     | 1.550   | 1.650  |
| D1     | 2.400     | 2.500   | 2.600  |
| A      | 0.700     | 0.750   | 0.800  |
| A1     | 0.000     | 0.020   | 0.050  |
| A2     | 0.497     | 0.547   | 0.597  |
| A3     | 0.203 REF |         |        |
| b      | 0.250     | 0.300   | 0.350  |
| e      | 0.65 BSC  |         |        |
| k      | 0.325 REF |         |        |
| L      | 0.350     | 0.400   | 0.450  |
| aaa    | 0.100     |         |        |
| ccc    | 0.100     |         |        |
| eee    | 0.080     |         |        |
| bbb    | 0.070     |         |        |
| fff    | 0.100     |         |        |



## TAPE AND REEL INFORMATION



|    |                                                           |
|----|-----------------------------------------------------------|
| A0 | Dimension designed to accommodate the component width     |
| B0 | Dimension designed to accommodate the component length    |
| K0 | Dimension designed to accommodate the component thickness |
| W  | Overall width of the carrier tape                         |
| P1 | Pitch between successive cavity centers                   |



PIN1 is in quadrant 1

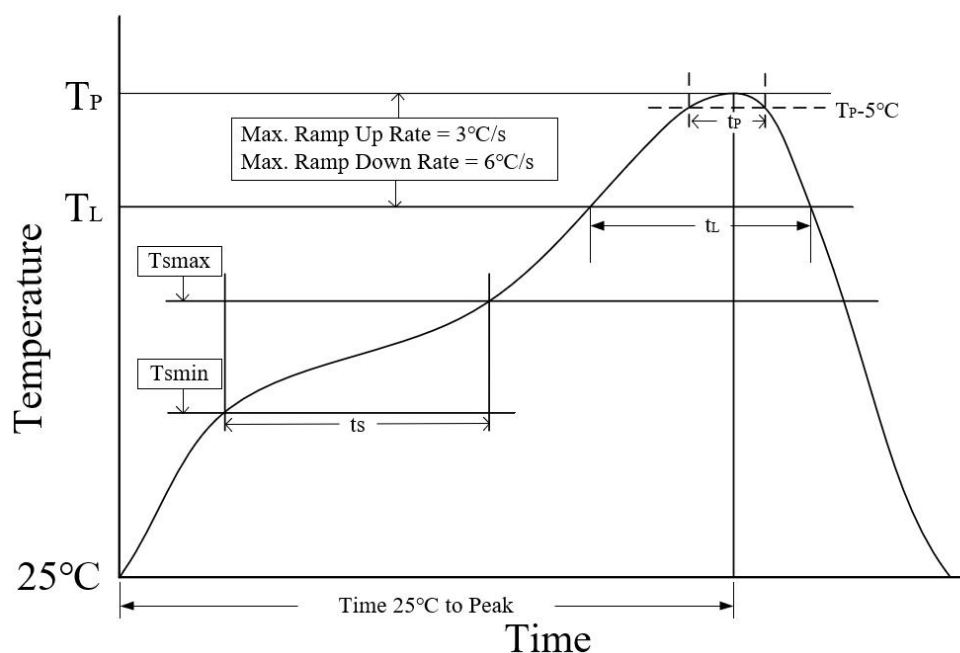
| Package Type | Reel Diameter A (mm) | Tape Width W1 (mm) | A0 (mm)  | B0 (mm)   | K0 (mm)  | P1 (mm)  | W (mm)    |
|--------------|----------------------|--------------------|----------|-----------|----------|----------|-----------|
| SOP8         | 330±1                | 12.4               | 6.60±0.1 | 5.30±0.10 | 1.90±0.1 | 8.00±0.1 | 12.00±0.1 |
| DFN3*3-8     | 329±1                | 12.4               | 3.30±0.1 | 3.30±0.1  | 1.10±0.1 | 8.00±0.1 | 12.00±0.3 |

**ORDERING INFORMATION**

| Type number  | Package                                         | MSL  | Packing       |
|--------------|-------------------------------------------------|------|---------------|
| SIT1042GT    | SOP8                                            | MSL3 | Tape and reel |
| SIT1042GT/3  | SOP8                                            | MSL3 | Tape and reel |
| SIT1042GTK/3 | DFN3*3-8, small shape,<br>no leads, 8 terminals | MSL3 | Tape and reel |

SOP8 is packed with 2500 pieces/disc in braided packaging. Leadless DFN3\*3-8 is packed with 6000 pieces/disc in braided packaging.

## REFLOW SOLDERING



| Parameter                                                                                  | Lead-free soldering conditions |
|--------------------------------------------------------------------------------------------|--------------------------------|
| Ave ramp up rate ( $T_L$ to $T_P$ )                                                        | 3 °C/second max                |
| Preheat time $t_s$<br>( $T_{smin}=150\text{ }^\circ C$ to $T_{smax}=200\text{ }^\circ C$ ) | 60-120 seconds                 |
| Melting time $t_L$ ( $T_L=217\text{ }^\circ C$ )                                           | 60-150 seconds                 |
| Peak temp $T_P$                                                                            | 260-265 °C                     |
| 5°C below peak temperature $t_P$                                                           | 30 seconds                     |
| Ave cooling rate ( $T_P$ to $T_L$ )                                                        | 6 °C/second max                |
| Normal temperature 25°C to peak temperature $T_P$ time                                     | 8 minutes max                  |

### Important statement

SIT reserves the right to change the above-mentioned information without prior notice.

**REVISION HISTORY**

| Version number | Data sheet status                                                                                                                                                                                                                                                        | Revision Date |
|----------------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|---------------|
| V1.0           | Initial version.                                                                                                                                                                                                                                                         | April 2026    |
| V1.1           | Optimized Flexible Data-Rate;<br>Added the parameter of Slew Rate;<br>Deleted $t_{\text{bit(BUS)}}$ , $t_{\text{bit(RXD)}}$ ;<br>Added CAN FD timing characteristic specifications that meet ISO 11898-2:2024 set C requirements;<br>Deleted the type number SIT1042GTK. | August 2026   |